

www.ironwoodelectronics.com



# Products, Services & Capabilities



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#### **Overview**

#### Company Overview

- Founded 1986
- Over 10,000 catalog products
- High Performance Adapters and Sockets
- Many Custom Designs & Turn-Key Solutions
- Engineering Electrical and Mechanical
- ISO9001:2015 Registration
- World wide distribution
- Customers Engineering and OEM
- 57 Employees

#### Capabilities Overview

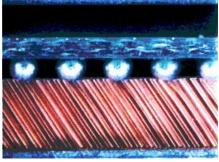
- Simulation
  - QFIN for heat sink design
  - Microwave Studio for electrical
- 3D Solid Modeling CAD & CAM
  - ProEngineer, Solid Works
  - Gibbs cam
- PCB Technology
  - PADS Layout, PADS Router
  - Controlled Impedance, Embedded Resistors, Laser Micro Vias, Filled Via in Pad, 3/3 traces, Rigid-flex PCBs
- State of the art CNC machines Tight Tolerance 3D Machining (e.g. ±0.0127mm), Swiss screw machine, Print, Pick, Place & Reflow assembly line, High speed PCB drilling, Laser cutting/drilling, Automated Optical Inspection, Impedance test, FDR test.

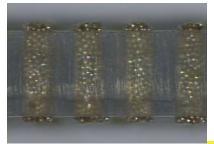
#### **Product Overview**

- Elastomer Sockets
- Spring Pin Sockets
- Manual Socket Lids
- Clamshell/Lever Actuation
- Zero footprint Sockets
- Near Zero footprint Sockets
- SMT Adapter Sockets
- SMT Package Emulation
- Package Convertors
- Prototype, Probing & Analysis Adapters
- Electronic Modules

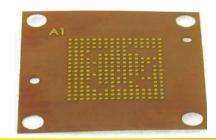
### **Engineering Sockets**







Silver particle





Heat sink lid

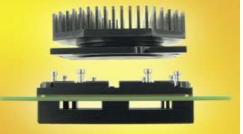
BGA compressed on Elastomer

Elastomer

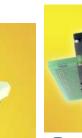


Capabilities

- 0.3mm to 1.27mm pitch
- 1x1mm to 60x60mm device
- BGA, LGA, QFN, QFP, SOIC, WLP
- 4000 pin count
- 75GHz
- Heat sink options
- Easy chip replacement
- Custom support plate options
- Custom mounting options
- Industry's smallest footprint



Swivel lid socket with decaps accommodated back plate



Back-to-back socket

Torque indicator





Surface mount adapter



Clamshell lid IP, 1/23/2020



Gold RF socket

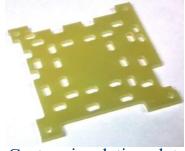


Open top lid



PoP socket with two elastomers

No mounting hole socket



Custom insulation plate





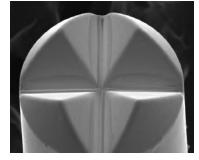
#### **Production & Burn-in Sockets**













Ceramic QFP socket

with center E-pad

**SMP** 

Stamped LGA pogo pin

Stamped BGA pogo pin

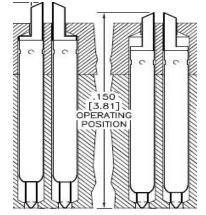
Self cleaning Pogo pin crown

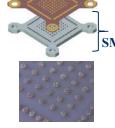
Short 3piece

Pogo pin



- 0.2mm to 1.27mm pitch
- 1x1mm to 60x60mm device
- BGA, LGA, QFN, QFP, SOIC, WLP
- 4000 pin count
- 45 GHz, 500K cycles
- Consistent contact resistance throughout life
- Low cleaning frequency
- High current & extreme temperature

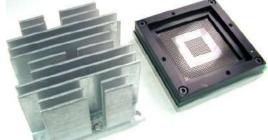




Offset plunger Kelvin pogo pin



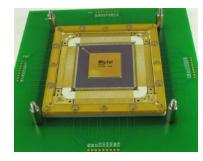
SOIC production socket



BGA production socket with heat sink lid



Multi Level SBT socket



Flat lead Ceramic QFP production socket

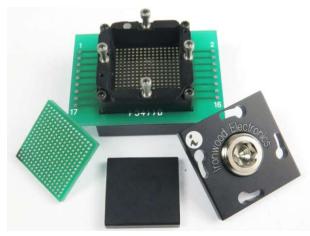


### **Socket Lid Options**

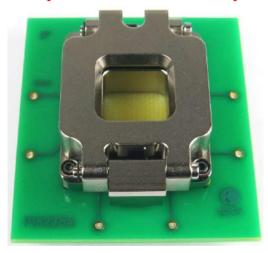
Swivel Lid Socket







Snap Lid Socket w/Center Open



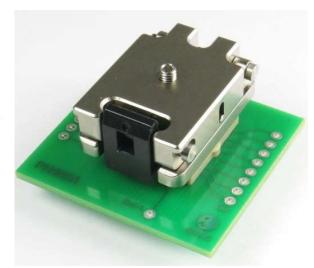
Double Latch Socket w/Center Open



Snap Lid with adjustable pressure screw Socket







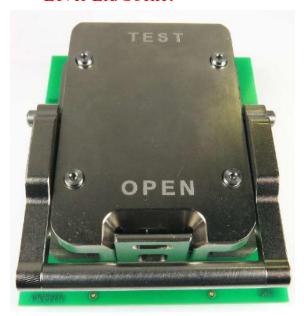
### **Socket Lid Options**







Lever Lid Socket



Clamshell Adjustable Hard Stop Socket



Lever Lid Socket w/Center Open

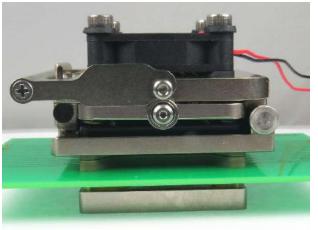


Clamshell Socket w/Heat Sink

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Lever Lid Socket w/Fan and Heat Sink



### **Contact Technology Summary**



<u>Characteristics</u>	Embedded Wire Elastomer (SG)	Stamped spring pins (SBT)	Embedded Silver Ball Elastomer Matrix (SM/SMP)	Silver Button Elastomer (GT/GTP)	
Bandwidth, GHz	27 to 56.8	4.15 to 31.7	44.8	94	
Endurance, Cycles*	2K	500K	5K/500K	1K/200K	
Resistance, $m\Omega$	20	15	15	20	
Self Inductance, nH	0.11 to 0.28	0.88 to 0.98	0.1	0.04	
Max Current, Amp	2	8	7.8	7.8	
Temp Range, ⁰C	-35 to +125	-55 to +180	-55 to +155	-55 to +160	
Pitch, mm	0.3 to 1.27	0.3 to 1.27	0.25 to 1.27	0.2 to 1.27	
Package Types	BGA, QFN, QFP, SOIC	BGA, LGA, QFN, QFP, SOIC	BGA, LGA, QFN	BGA, LGA, QFN	
Lab test	$\sqrt{}$	$\sqrt{}$	$\sqrt{}$	$\sqrt{}$	
Production test		$\checkmark$	$\sqrt{}$	$\sqrt{}$	
Field upgrade	$\checkmark$	$\checkmark$	$\sqrt{}$	$\sqrt{}$	
Temperature test	V	V	V		
Kelvin test	$\sqrt{}$	$\sqrt{}$	$\sqrt{}$		
Burn-in test		$\sqrt{}$			

<sup>\*</sup>Cycle life shown at room temperature. Reduced cycle life is expected when used at extreme temperatures, thermal cycling, improper force, cleaning and handling.

#### **Pin Datasheet**





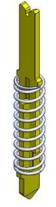


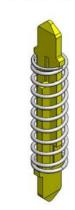












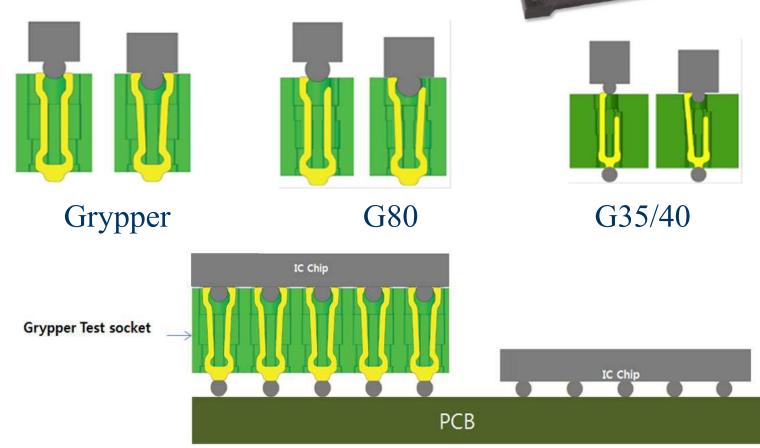
Pin Family	SBT						
Part Number	P-P204A	P-P185A	P-P184A	P-P196A	P-P150A	P-P151A	P-P152A
Minimum Pitch (mm)	0.35	0.4	0.4	0.5	0.5	1.0	1.0
Pin Type	BGA	BGA	LGA	BGA	LGA	BGA	LGA
Length (mm)	3.46	3.81	2.9	3.86	2.95	5.69	4.45
DUT Side Tip Shape	Crown	V Shape	Radius Cone	V Shape	Radius Cone	Notched V	Radius Cone
DUT Side Tip Dimension (mm)	0.17	0.14	0.12	0.2	0.06	0.54	0.1
PCB Side Tip Shape	Radius Cone						
PCB Side Tip Dimension (mm)	0.12	0.12	0.12	0.04	0.06	0.1	0.1
DUT Side Travel (mm)	0.3	0.5	0.3	0.33	0.33	0.6	0.6
PCB Side Travel (mm)	0.1	0.1	0.1	0.1	0.1	0.1	0.1
Force (g)	8.7	17	14.5	30	30	19	19
Cres (mOhms)	< 70	< 50	< 50	< 30	< 30	< 15	< 15
CCC @ ambient (Amps)	1	1.8	1.8	4.0	6.0	8.0	8.0
Bandwidth (GHz @ -1dB)**	23.5 - 26.1	20.5 - 31.7	20.5 - 31.7	5.2 - 15.7	5.2 - 15.7	14.1 - 21.9	14.1 - 21.9
Self inductance (nH)	0.92	0.98	0.98	0.88	0.88	0.93	0.93
Temperature (deg C)	-55 to +180C						
Insertion Cycles	50K	50K	50K	500K	500K	500K	500K

<sup>\* 0.4</sup>mm/0.5mm pitch SBT pins are used in 0.65mm and 0.8mm pitch applications

<sup>\*\*</sup> Bandwidth range is based on pin location (corner, edge, field). See report for test conditions and setup.

#### **Zero Footprint Sockets**

- No lid required
- Socket same size as device
- device simply snaps in for test
- Allows test on platform boards



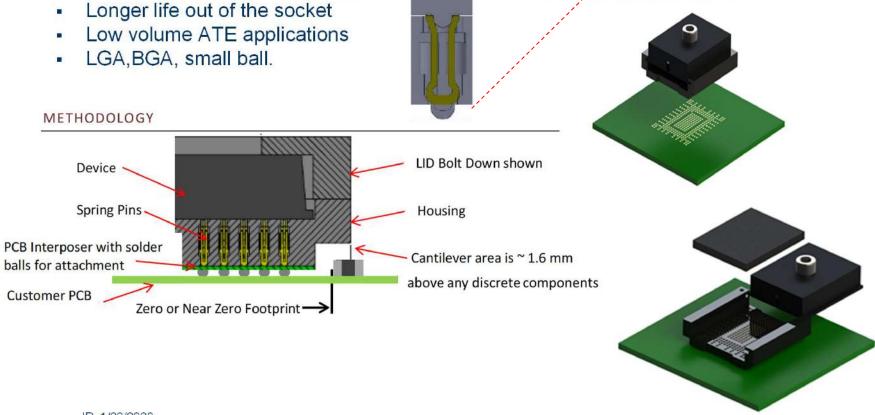


Ironwood

#### **Near Zero Footprint Sockets**

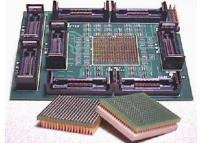


- "Y" contact technology:
  - Does have a cover
  - Great for vibration testing
  - Still near zero footprint
  - Test same device up to 200+ times with little mark on the ball
- "Spring Pin" contact technology:
  - Same attributes of "Y" solution.



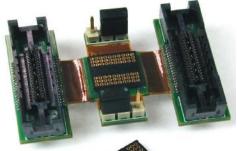
### **Engineering Adapters**











60 pin, 0.8mm pitch BGA

rigid-flex probing adapter with AMP mictor and

BGA surface mount foot

Power PC BGA device interfaced to Logic analyzer and mother board for functional analysis

0.5mm pitch 21x21 array 289 position BGA solder balls to AMP 104068 connectors using rigid flex PCB with socket fixture



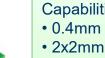
Gull-wing QFP

Leadless QFN emulator

IP, 1/23/2020

**Emulator foot** 

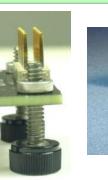




- Agilent, Tektronix compatible
- Rigid & flex options



- 0.4mm to 1.27mm pitch
- 2x2mm to 50x50mm device
- BGA, LGA, QFN, SOIC, PLCC, QFP, DIP, PGA, etc
- 2000 pin count
- RoHS compatible



Allows QFN device to be socketed to mother board with signals brought out to test pins



Flex emulator – 125 position AMP Z pack connector to 80 position female interface



Proven Capability



### **Production Adapters**









Daughter card module Interfaced to QFP footprint



0.5mm pitch BGA

Pluggable adapter system

QFP device mounted to PLCC Footprint



SoC module with high density connector



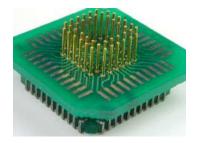
- 0.4mm to 2.54mm pitch
- 2x2mm to 50x50mm device
- BGA, LGA, QFN, SOIC, PLCC, QFP, DIP, PGA, etc
- 3 mil trace/space
- Laser micro vias
- Embedded caps & resistors
- Lead free options
- Tray, Tape & Reel options
- Turnkey solutions



2000 pin count BGA adapter system plugged together IP, 1/23/2020



SOIC to DIP convertor using blind hole technology



PLCC plug connects Daughter card to socket



SOIC device mounted to PLCC footprint using solder column technology for high volume production





SOIC pitch convertor





## **Facility Overview**

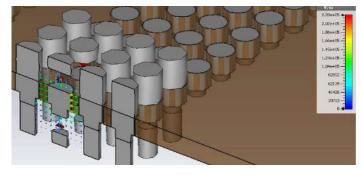


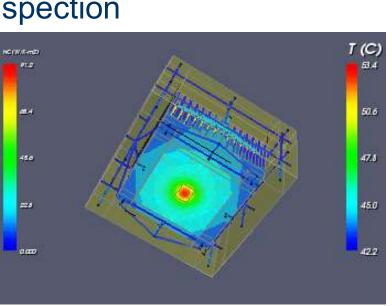
Production area 24000 Sq. Ft Building ESD Automated Assembly area

## **Custom Capabilities**



- Custom designs in 2 days
- Match customer's PCB footprint
- Custom manufacturing in 10 days
- Multiple contactor technologies
- Heat sink simulation and design
- Contactor signal integrity simulation
- In-house automated optical inspection
- In-house machining
- Quick turn production







## **Global Presence**



